



DMG4N65CT

#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON) MAX</sub>	Package	I <sub>D MAX</sub> T <sub>C</sub> = +25°C	
650V	$3.0\Omega@V_{GS} = 10V$	TO220-3	4.0A	

## **Description**

This new generation complementary MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

#### **Applications**

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

#### **Features**

- Low Input Capacitance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: TO220-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish-Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 e3
- Terminal Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

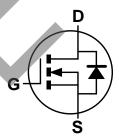
#### TO220-3



Top View



Top View Pin Out Configuration



**Equivalent Circuit** 

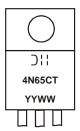
## Ordering Information (Note 4)

		<u> </u>	
Part Number		Case	Packaging
DMG4N65CT		TO220-3	50 pieces/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



⊃¹¹= Manufacturer's Marking
 4N65CT = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 19 = 2019)
 WW = Week (01 to 53)

DMG4N65CT Document number: DS35719 Rev. 5 - 4



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic				Value	Unit	
Drain-Source Voltage			$V_{DSS}$	650	V	
Gate-Source Voltage			V <sub>GSS</sub>	±30	V	
Continuous Drain Current (Note 5)	Steady	T <sub>C</sub> = +25°C		4.0	۸	
V <sub>GS</sub> = 10V	State	T <sub>C</sub> = +70°C	ID	3.0	A	
Pulsed Drain Current (Note 7)			I <sub>DM</sub>	6	Α	
Avalanche Current (Note 8) V <sub>DD</sub> = 10	00V, V <sub>GS</sub> = 10V, L	_ = 60mH	I <sub>AS</sub>	3.9	Α	
Repetitive avalanche energy (Note 7)				456	mJ	

## **Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	$P_{D}$	2.19	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	RθJA	58.5	°C/W
Power Dissipation (Note 6)	P <sub>D</sub>	9.14	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	Reja	2.85	°C/W
Thermal Resistance, Junction to Case @T <sub>A</sub> = +25°C (Note 6)	Rejc	0.86	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	650		_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>		_	1.0	μΑ	$V_{DS} = 650V, V_{GS} = 0V$	
Gate-Source Leakage	$I_{GSS}$		_	±100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	3	_	5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	_	2.1	3.0	Ω	$V_{GS} = 10V, I_D = 2A$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	3.7		S	$V_{DS} = 40V, I_{D} = 2A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.0	V	$V_{GS} = 0V, I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C <sub>iss</sub>	_	900	_		)/ OF\/ \/ O\/	
Output Capacitance	Coss	_	50		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	1.1	_		I = 1.0IVII IZ	
Gate Resistance	$R_g$	_	2.4		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	13.5	_		10)/ )/ 500)/	
Gate-Source Charge	$Q_{gs}$	_	2.7	_	nC	$V_{GS} = 10V, V_{DS} = 520V,$	
Gate-Drain Charge	$Q_{gd}$	_	3.8	_		$I_D = 4A$	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	15.1	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	13.8	_	ns	$V_{GS} = 10V, V_{DS} = 325V,$ $R_g = 25\Omega, I_D = 4A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	40	_	ns		
Turn-Off Fall Time	t <sub>F</sub>		16	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>		515	_	ns	$dI/dt = 100A/\mu s$ , $V_{DS} = 100V$ ,	
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	2330		nC	$I_F = 4A$	

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- 6. Device mounted on an infinite heatsink
- 7. Repetitive rating, pulse width limited by junction temperature.
- 8.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to production testing.

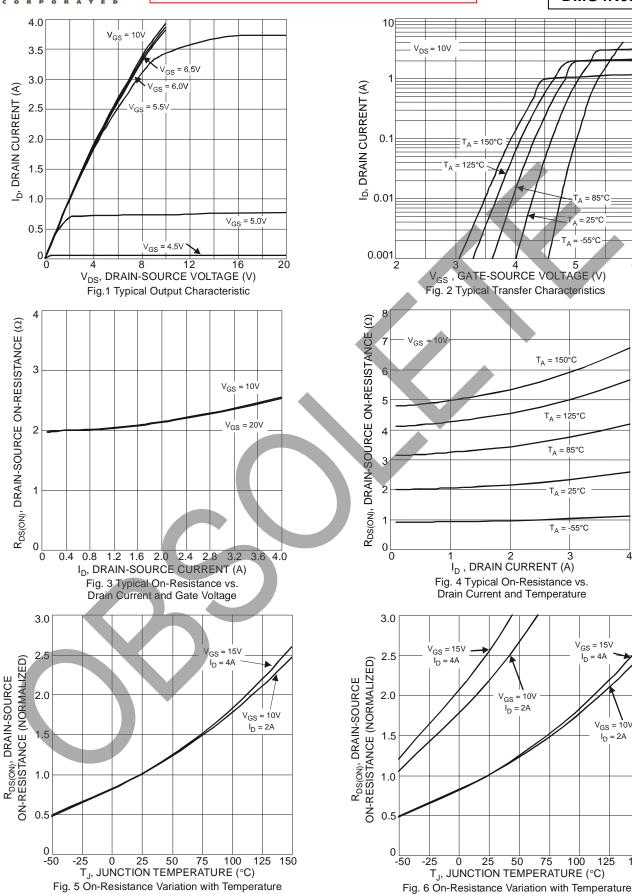
= 85°C = 25°C

- -55°C

 $V_{GS} = 15V$ 

= 4A

 $V_{GS} = 10V$  $I_D = 2A$ 





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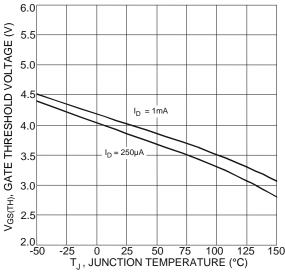


Fig. 7 Gate Threshold Variation vs. Junction Temperature

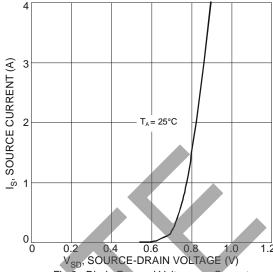


Fig.8 Diode Forward Voltage vs. Current

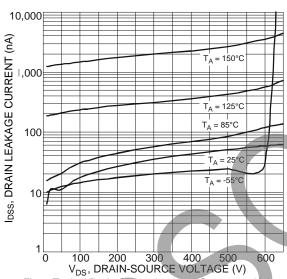
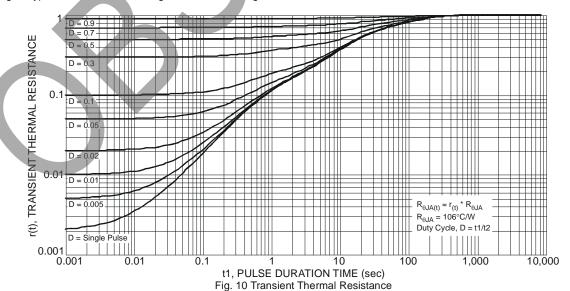


Fig. 9 Typical Drain-Source Leakage Current vs. Voltage

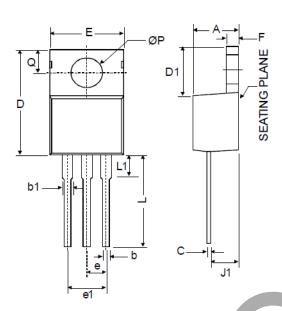




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO220-3



TO220-3					
Dim	Min	Max			
A	3.55	4.85			
ь	0.51	1.14			
<b>b1</b>	1,14	1.78			
С	0.31	1.14			
D	14.20	16.50			
D1	5.84	6.86			
E	9.70	10.70			
е	2.79	2.99			
e1	4.83	5.33			
F	0.51	1.40			
J1	2.03	2.92			
L	12.72	14.72			
L1	3.66	6.35			
P	3.53	4.09			
Q	2.54	3.43			
All Dimensions in mm					



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DMG4N65CT Document number: DS35719 Rev. 5 - 4